

UltraCMOS® SPDT RF Switch 100 – 6000 MHz

Product Description

The PE42420 is a HaRP™ technology-enhanced absorptive 50Ω SPDT RF switch developed on the UltraCMOS® process technology.

This general purpose switch is comprised of two RF ports and has very high isolation performance. It is ideal for RF and IF transceiver signal switching (signal amplitude adjust), discrete DSA stages, and filter bank switching applications. No blocking capacitors are required if DC voltage is not present on the RF ports.

Peregrine's HaRP™ technology enhancements deliver high linearity and excellent harmonics performance with the economy and integration of conventional CMOS.

Features

- HaRP™ technology enhanced
 - No gate and phase lag
 - No drift in insertion loss and phase
- Supports +1.8V control logic
- High linearity
 - IIP3 of 65 dBm
- High isolation
 - 69 dB @ 1 GHz
 - 62 dB @ 3 GHz
 - 50 dB @ 6 GHz
- High ESD tolerance
 - 4kV HBM on RFC
 - 2kV HBM on all other pins

Figure 1. Functional Diagram

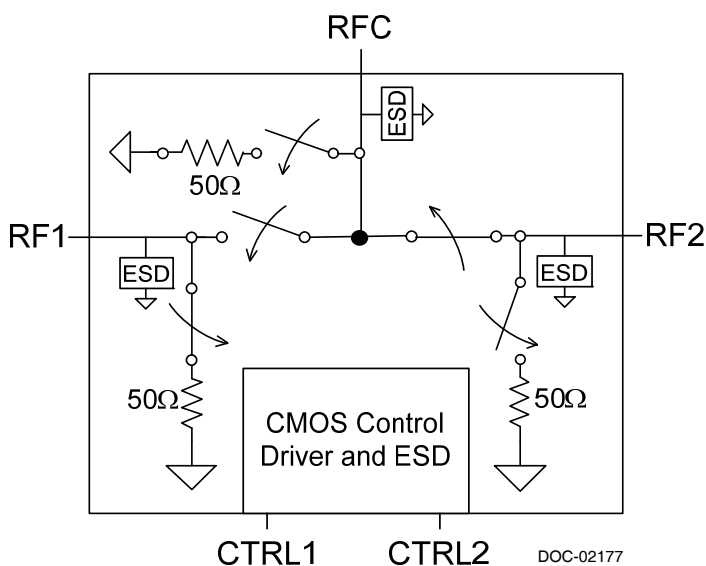


Figure 2. Package Type
20-lead 4x4 mm LGA

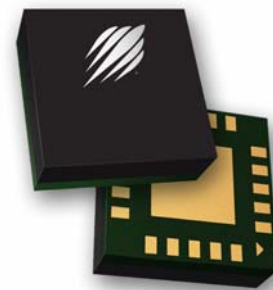


Table 1. Electrical Specifications Typical @ 25°C, V_{DD} = 3.0V (Z_S = Z_L = 50Ω)

Parameter	Path	Condition	Min	Typ	Max	Unit
Operating frequency			100		6000	MHz
Insertion loss	RFC–RFX	100–1000 MHz		0.95	1.15	dB
		1000–2000 MHz		0.95	1.15	dB
		2000–3000 MHz		1.00	1.2	dB
		3000–4000 MHz		1.15	1.35	dB
		4000–5000 MHz ¹		1.25	1.55	dB
		5000–6000 MHz ¹		1.60	1.9	dB
Isolation	RFX–RFX	100–1000 MHz	67	69		dB
		1000–2000 MHz	63	64		dB
		2000–3000 MHz	59	62		dB
		3000–4000 MHz	60	64		dB
		4000–5000 MHz	54	60		dB
		5000–6000 MHz	44	50		dB
Isolation	RFC–RFX	100–1000 MHz	69	71		dB
		1000–2000 MHz	65	67		dB
		2000–3000 MHz	63	68		dB
		3000–4000 MHz	62	67		dB
		4000–5000 MHz	52	57		dB
		5000–6000 MHz	44	48		dB
Return loss	All ports	100–4000 MHz		20		dB
		4000–5000 MHz ¹		15		dB
		5000–6000 MHz ¹		13		dB
Input 1 dB compression point ²	RFC–RFX	100–6000 MHz	33			dBm
Input IP2	RFC–RFX	100–6000 MHz		110		dBm
Input IP3	RFC–RFX	100–6000 MHz	60	65		dBm
Switching time		50% CTRL to 90% or 10% RF		300	400	ns

Notes: 1. Insertion loss and return loss can be improved by external matching

2. The input 1dB compression point is a linearity figure of merit. Refer to *Table 3* for the maximum operating power P_{IN} (50Ω)

Figure 3. Pin Configuration (Top View)

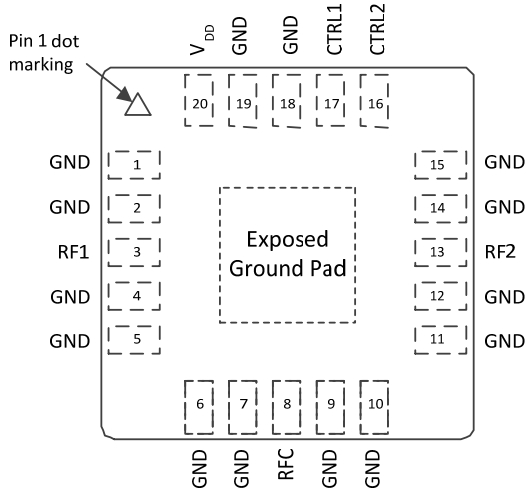


Table 2. Pin Descriptions

Pin #	Pin Name	Description
1, 2, 4-7, 9, 10-12, 14, 15, 18, 19	GND	Ground
3	RF1 ¹	RF port
8	RFC ¹	RF common
13	RF2 ¹	RF port
16	CTRL2	Digital control logic input 2
17	CTRL1	Digital control logic input 1
20	V _{DD}	Supply voltage
Pad	GND	Exposed pad: ground for proper operation

Note 1: RF pins 3, 8 and 13 must be at 0V DC. The RF pins do not require DC blocking capacitors for proper operation if the 0V DC requirement is met

Table 3. Operating Ranges

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V _{DD}	2.7		5.5	V
Supply current V _{DD} = 2.7 to 5.5V	I _{DD}		120	200	μA
Digital input high (CTRL1, CTRL2)	V _{IH}	1.17		3.6	V
Digital input low (CTRL1, CTRL2)	V _{IL}	-0.3		0.6	V
Digital input current	I _{CTRL}		9	12	μA
Maximum operating power (RFC-RFX) ¹	P _{IN}			30	dBm
Maximum power into termination (RFX) ¹	P _{MAX}			20	dBm
Operating temperature range	T _{OP}	-40		+85	°C

Notes: 1. 100% duty cycle, all bands, 50Ω

Table 4. Absolute Maximum Ratings

Parameter/Condition	Symbol	Min	Max	Unit
Supply voltage	V _{DD}	-0.3	5.5	V
Digital input voltage (CTRL1, CTRL2)	V _{CTRL}	-0.3	3.6	V
Operating power (RFC-RFX) ¹	P _{IN}		30	dBm
Power into termination (RFX) ¹	P _{MAX}		20	dBm
Storage temperature range	T _{ST}	-65	+150	°C
Maximum die junction temperature	T _{Jmax}		+125	°C
ESD voltage HBM ² RFC All other pins	V _{ESD}		4000 2000	V V
ESD voltage MM ³ , all pins	V _{ESD}		100	V

Notes: 1. 100% duty cycle, all bands, 50Ω
2. Human Body Model (MIL-STD 883 Method 3015)
3. Machine Model (JEDEC JESD22-A115)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS® device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS® devices are immune to latch-up.

Switching Frequency

The PE42420 has a maximum 25 kHz switching frequency.

Switching frequency describes the time duration between switching events. Switching time is the time duration between the point the control signal reaches 50% of the final value and the point the output signal reaches within 10% or 90% of its target value. Switching time is provided in *Table 1*.

Table 5. Truth Table

CTRL1	CTRL2	RFC – RF1	RFC – RF2
Low	Low	OFF	OFF
Low	High	OFF	ON
High	Low	ON	OFF
High	High	N/A ¹	N/A ¹

Note 1: CTRL1 = High and CTRL2 = High are not supported

Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE42420 in the 20-lead 4x4 mm LGA package is MSL3.

Spurious Performance

The typical spurious performance of the PE42420 is –155 dBm.

Typical Performance Data @ 25°C and $V_{DD} = 3.0V$ unless otherwise specified

Figure 4. Insertion Loss (RFC-RFX)

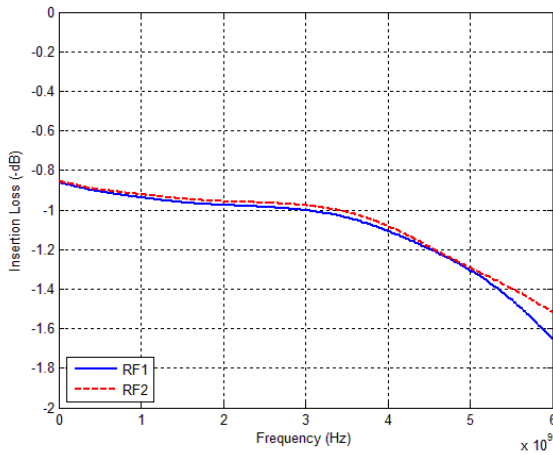


Figure 5. Insertion Loss vs Temp (RFX-RFC)

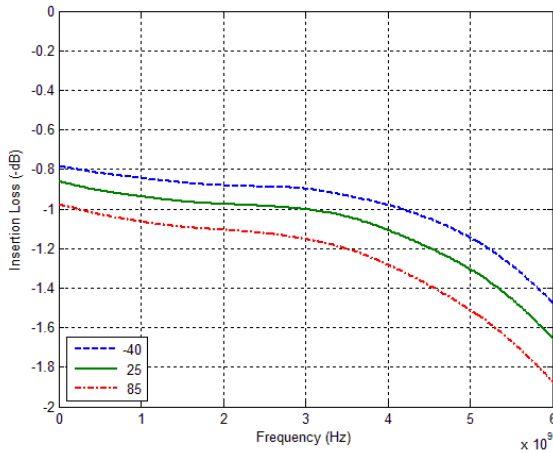


Figure 6. Insertion Loss vs V_{DD} (RFX-RFC)

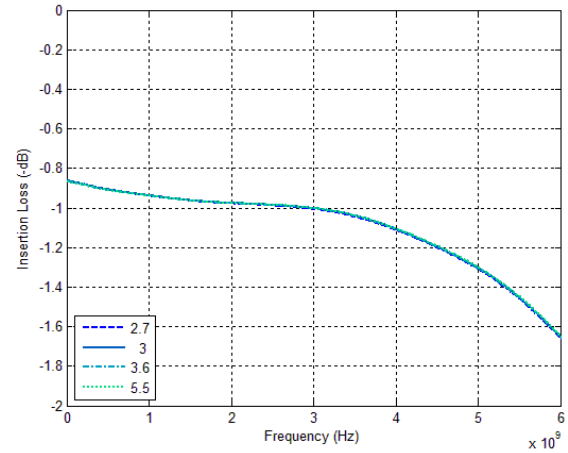


Figure 7. RFC Port Return Loss vs Temp (RF1 Active)

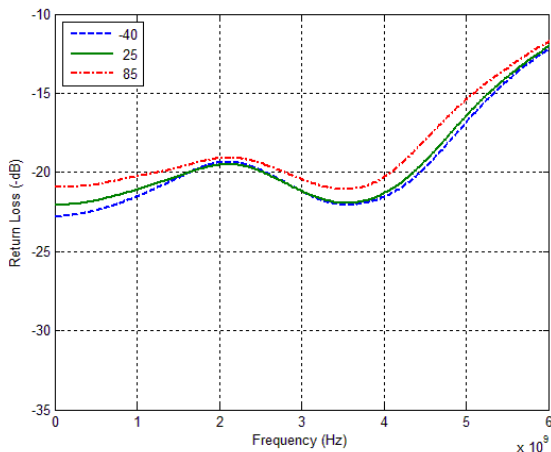
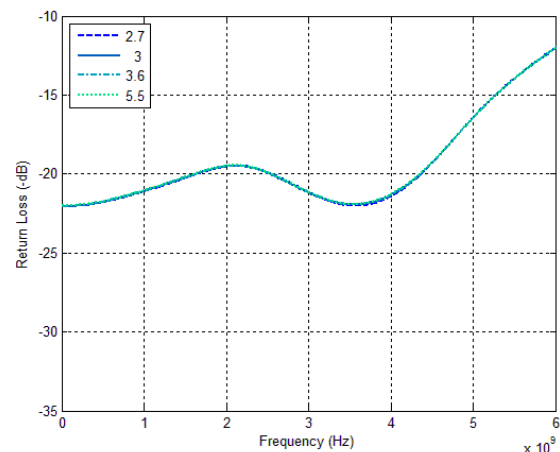


Figure 8. RFC Port Return Loss vs V_{DD} (RF1 Active)



Typical Performance Data@ 25°C and $V_{DD} = 3.0V$ unless otherwise specified

Figure 9. RFC Port Return Loss vs Temp (RF2 Active)

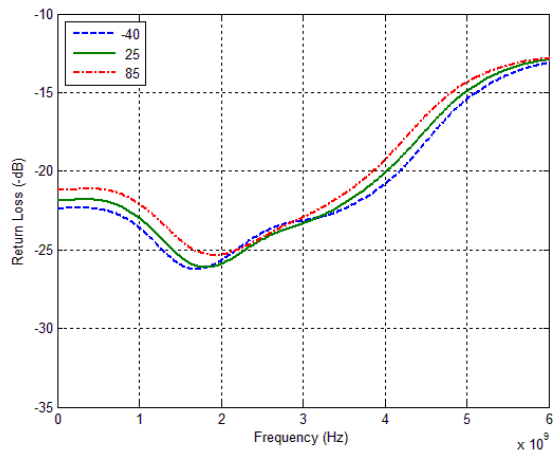


Figure 10. RFC Port Return Loss vs V_{DD} (RF2 Active)

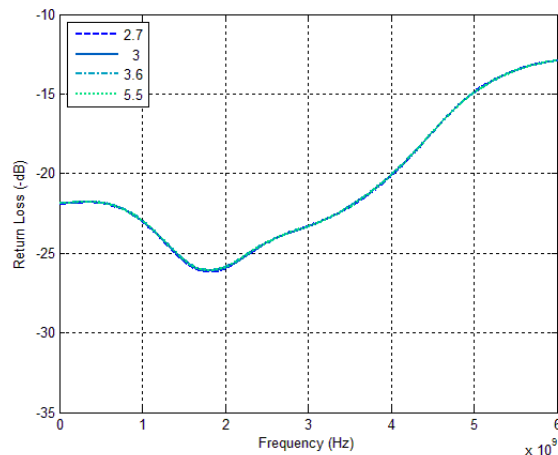


Figure 11. Active Port Return Loss vs Temp (RF1 Active)

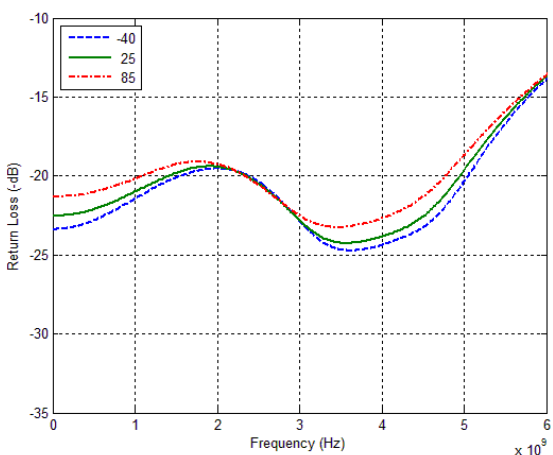


Figure 12. Active Port Return Loss vs V_{DD} (RF1 Active)

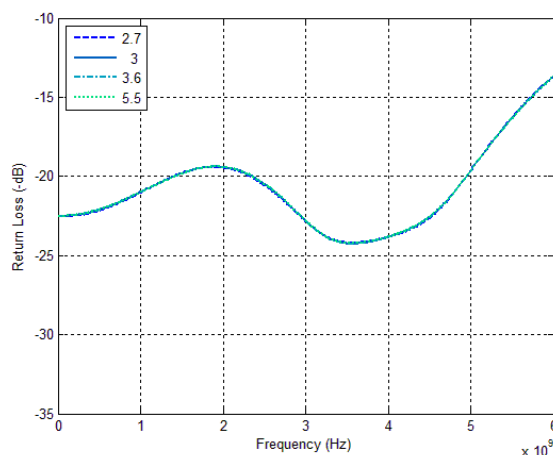


Figure 13. Terminated Port Return Loss vs Temp (RF1 Active)

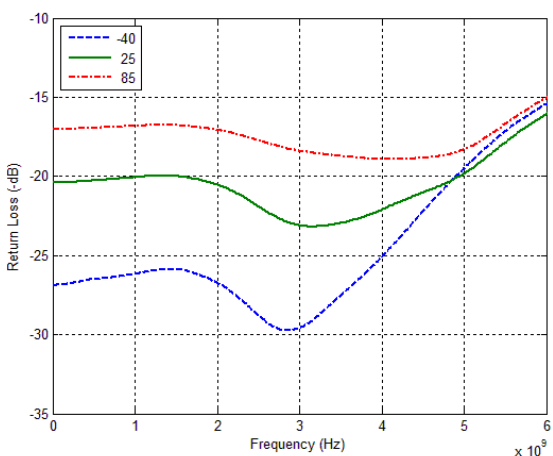
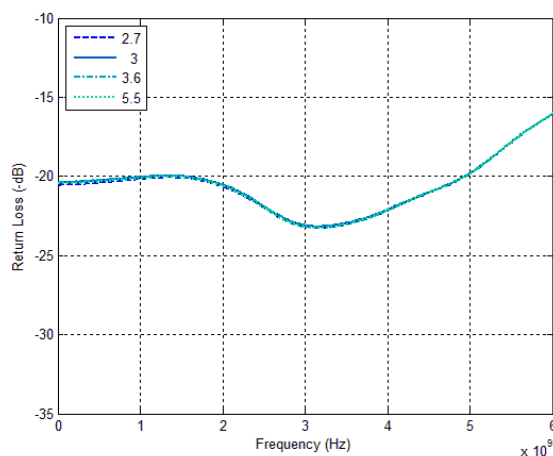


Figure 14. Terminated Port Return Loss vs V_{DD} (RF1 Active)



Typical Performance Data@ 25°C and $V_{DD} = 3.0V$ unless otherwise specified

Figure 15. Isolation vs Temp (RFX-RFX)

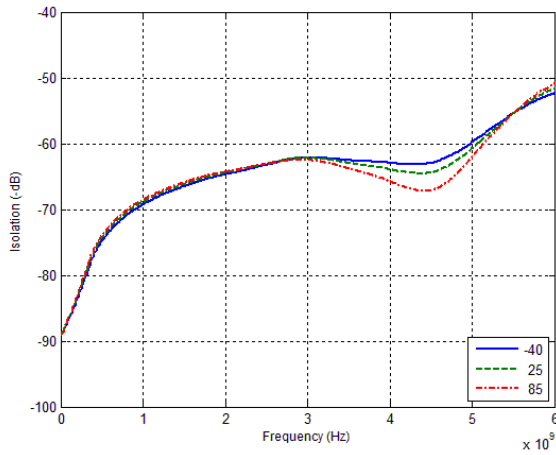


Figure 16. Isolation vs V_{DD} (RFX-RFX)

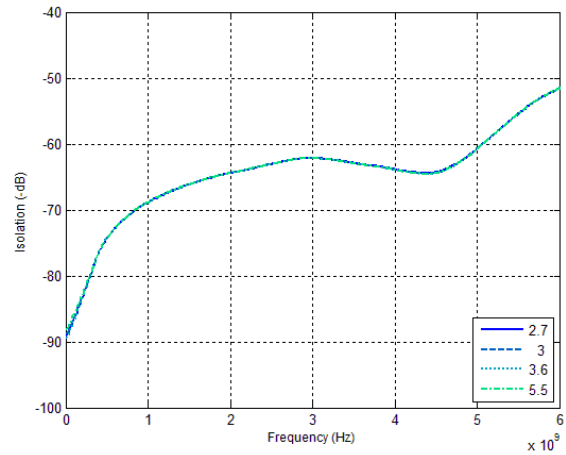


Figure 17. Isolation vs Temp (RFC-RFX)

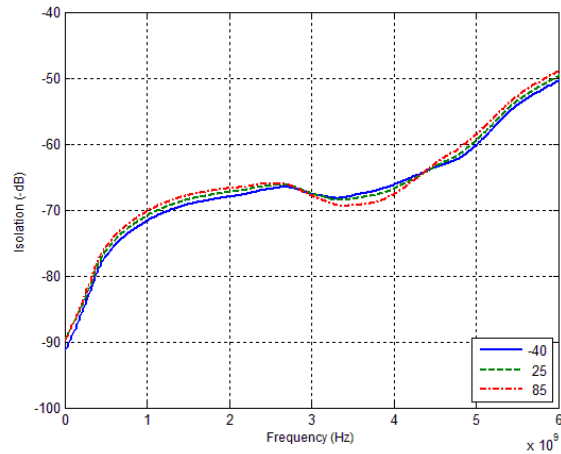
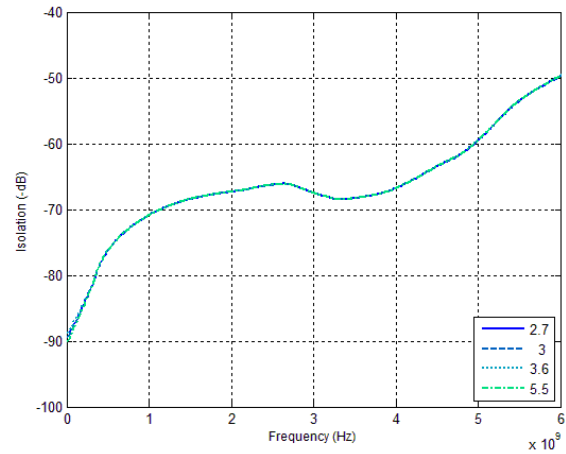


Figure 18. Isolation vs V_{DD} (RFC-RFX)



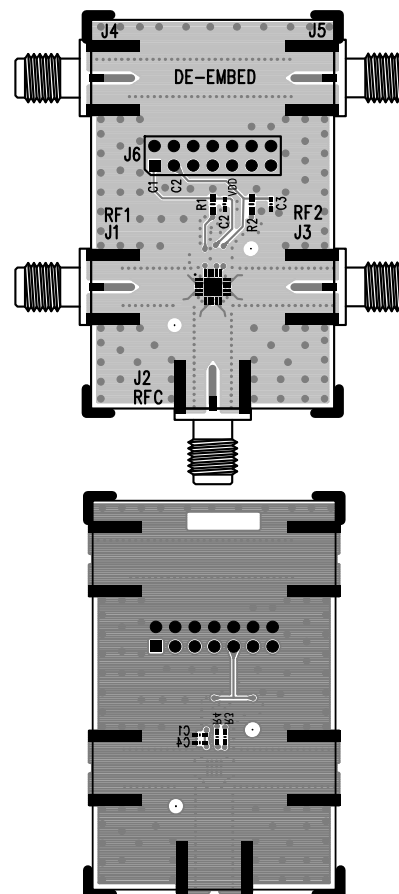
Evaluation Kit

The SPDT switch evaluation board was designed to ease customer evaluation of Peregrine's PE42420. The RF common port is connected through a 50 Ω transmission line via the top SMA connector, J2. RF1 and RF2 ports are connected through 50 Ω transmission lines via SMA connectors J1 and J3, respectively. A 50 Ω through transmission line is available via SMA connectors J4 and J5, which can be used to calculate the loss of the PCB. J6 provides DC and digital inputs to the device.

The board is constructed of a four metal layer material with a total thickness of 36 mils. To achieve high isolation, the 50 Ω transmission lines are designed in layer 2 using a stripline waveguide design. The board stack up for 50 Ω transmission lines has 10 mil thickness of Rogers 4350 between layer 1 and layer 2, and 10 mil thickness of Rogers 4350 between layer 2 and layer 3.

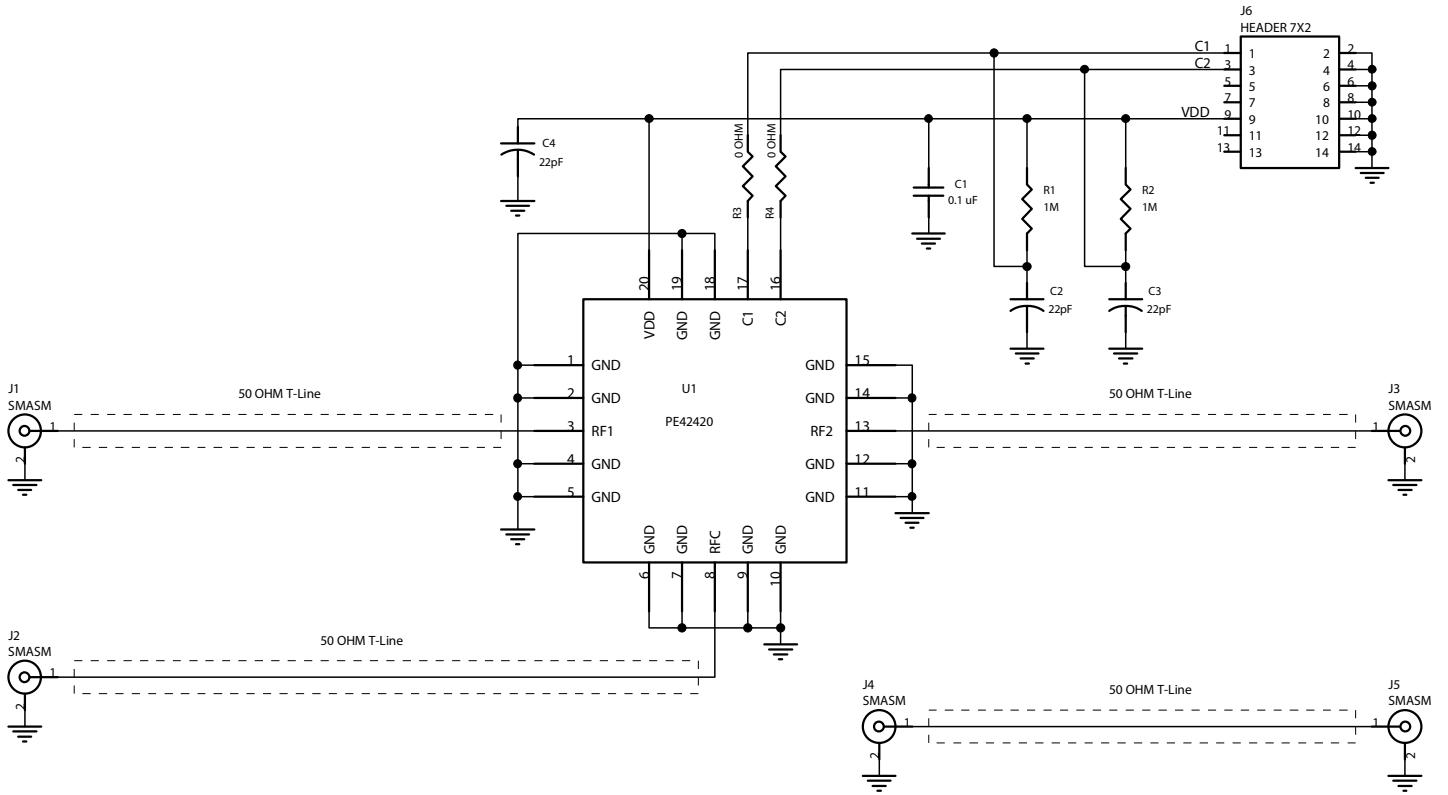
For the true performance of the PE42420 to be realized, the PCB should be designed in such a way that RF transmission lines and sensitive DC I/O traces are heavily isolated from one another.

Figure 19. Evaluation Board Layouts



101-0551

Figure 20. Evaluation Board Schematic



DOC-14527

Figure 21. Package Drawing
20-lead 4x4 mm LGA

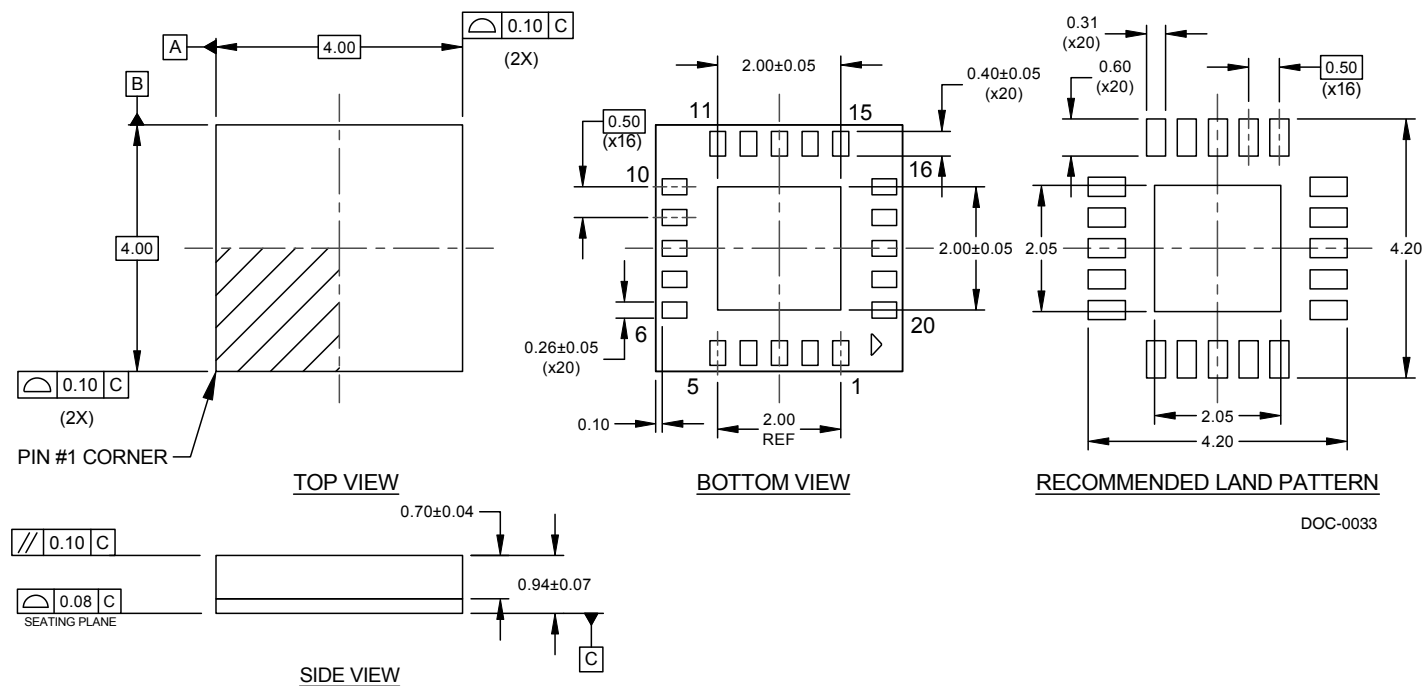
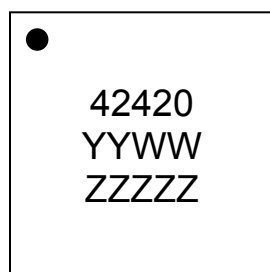


Figure 22. Top Marking Specifications



● = Pin 1 designator
YYWW = Date Code
ZZZZZ = Last five digits of Lot Number

DOC-01641

Technical drawing of a 4-hole tape reel. The drawing includes a top view and a side view labeled **Section A-A**.

Top View Dimensions:

- Overall width: 12.0 ± 0.3
- Overall height: 5.5 ± 0.05 (See Note 6)
- Distance between hole centers (pitch): 8.0
- Distance from left edge to first hole center: A_o
- Distance from right edge to last hole center: 1.75
- Hole diameter: $\varnothing 1.5 \pm 0.1 / -0.0$
- Minimum hole diameter: $\varnothing 1.5 \text{ MIN}$
- Distance from top edge to hole center line: 2.0 ± 0.05 (See Note 6)
- Distance from bottom edge to hole center line: 4.0 (See Note 1)
- Radius of corner: $R0.25$
- Radius of internal corner: $R0.3 \text{ MAX}$
- Radius of hole: 0.25

Section A-A Dimensions:

- Overall width: 0.30 ± 0.05
- Radius of corner: $R0.3 \text{ MAX}$
- Distance from left edge to hole center line: K_o

Other Features:

- Section line **A-A** is shown on the right side of the reel.
- Direction of tape feed is indicated by a dashed arrow pointing right, labeled "Tape Feed Direction".

- $A_o = 4.35 \text{ mm}$
 $B_o = 4.35 \text{ mm}$
 $K_o = 1.1 \text{ mm}$

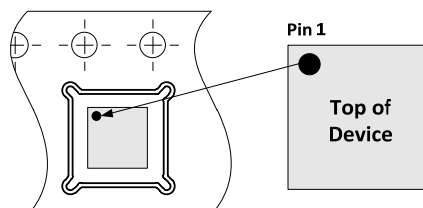


Table 6. Ordering Information

Order Code	Description	Package	Shipping Method
PE42420LGBB-Z	PE42420 SPDT RF switch	Green 20-lead 4x4 mm LGA	3000 units / T&R
EK42420-02	PE42420 Evaluation kit	Evaluation kit	1 / Box

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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